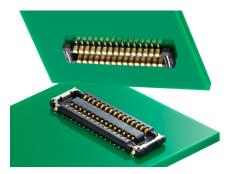
SlimStack Board-to-Board Connectors, 0.40mm Pitch, B8 Series

molex

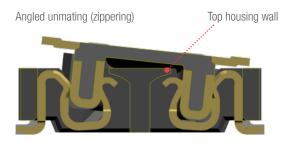
0.40mm pitch, 0.80mm height, SlimStack B8 connectors with CleanPoint contact design have robust features that remove contaminants and prevent damage when subjected to harsh handling.

As future devices continue to increase in value and complexity, designers need to stabilize connections to avoid the need for costly rework and/or repair. Building reliability into connector designs for any devices is critical. In the production process of flex-to-board jumpers, flux or dust can sometimes settle on contacts and disrupt signal continuity. Molex's B8 series includes a CleanPoint contact design with a beveled shape that can remove flux and other contaminants to provide a more stable electrical signal.



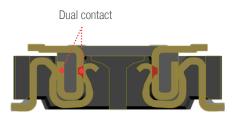
Features and Advantages

Top Housing Wall Top housing wall (stopper) prevents the terminal from lifting up due to "zippering" or angled unmating



Dual-Contact Design

A dual-contact design on Molex's SlimStack B8 series absorbs drop-shock discontinuity to help guarantee that a stable signal is maintained even when the device is subjected to rough handling

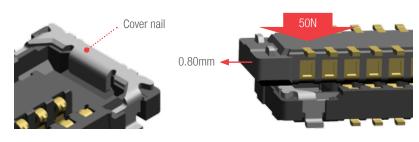


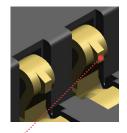
Cover Nail

Cover nail protects the housing from damage during blind mating or angled unmating (zippering). Mating tests on the outer wall of Molex's B8 connectors demonstrate no damage to housing with up to 50N of force and 0.80mm displacement

SlimStack B8 CleanPoint Contact

Molex's CleanPoint contact design provides superior electrical reliability and removes foreign materials such as flux





CleanPoint contact

Applications

Mobile Devices

Smartphones Tablet PCs Wearable Devices Portable Audio Portable Navigation Equipment



Smartphone



Wearables



Portable Navigation

SlimStack Board-to-Board Connectors, 0.40mm Pitch, B8 Series

molex

Specifications

REFERENCE INFORMATION

Packaging: Embossed Tape and Reel Designed In: Millimeters RoHS: Yes Halogen Free: Low-Halogen

ELECTRICAL

Voltage (max.): 50V Current (max.): 0.3A per circuit Contact Resistance (max.): 80 milliohms Dielectric Withstanding Voltage: 250V AC Insulation Resistance (min.): 100 Megohms

MECHANICAL

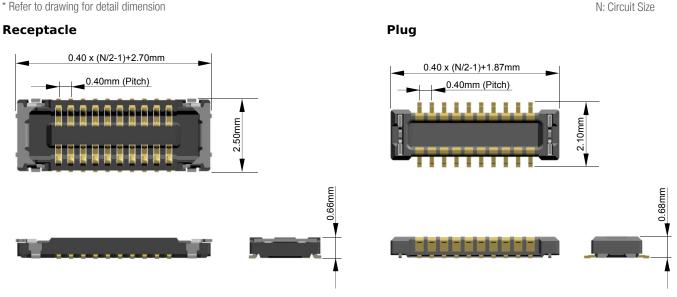
Durability (max.): 30 cycles

PHYSICAL

Housing: LCP, UL 94V-0, Black Contact: Copper Alloy Plating: Contact Area – Gold Solder Tail Area - Gold Underplating – Nickel Operating Temperature: -40 to +85℃

Dimensions

* Refer to drawing for detail dimension



Ordering Information

Order No.		Description	Motod Upight (mm)	Mated Width (mm)	Circuits
Receptacle	Plug	Description	Mated Height (mm)	mated width (mm)	Circuits
<u>505550 -**20</u>	<u>505551 -**20</u>	Connectors with nail edge inside housing edge	0.80	2.50	10, 16, 20, 24, 30, 34, 40, 50

**: Circuit Size

www.molex.com/link/slimstack.html

Molex is a registered trademark of Molex, LLC in the United States of America and may be registered in other countries; all other trademarks listed herein belong to their respective owners.